

# 产品规格书

# PRODUCT SPECIFICATION

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产品规格: <b>GJ-A1003</b> 系列	No.:	Date Issued:
	EN-103(2019-04)	2022.11.07
Specification: C.I. A 1002 Series	Rev.:	Date Revised:
Specification: GJ-A1003 Series	A.0	
Pitch 1.00mm Series Wire to Board	Issued by:	
File 1.00mm Series wire to Board	Connector	Engineering Dept.

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# 东莞市高嘉精密电子有限公司

DONGGUAN GAOJIA PRECISION ELECTRONICS CO.,LTD

Type Document	Product Specification	Revised /Edition	A	
Date Issued	2022/11/07	Data Revised		
Subject: GJ-A1003TF-PTS	Issued By:			
Pitch 1.00mm S	Pitch 1.00mm SMT (Non-Halogen)Series Wire to Board Connector			

# This specification is referred to 1.00mm SMT(Non-Halogen )series wire to board connector.

本規格書內容係提供 1.00 mm SMT (無鹵素)系列產品相關參考, 其用途為電線端相接於電路板端連接器

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REV. (版次)	Revision Record (改版變更原因)	Date(日期)	ECN No





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#### 1.0 Product Name/Part Number & Drawing Number(產品名稱 / 產品型號及圖面型號):

Product Name(產品名稱)		Part Number(零件型號) Drawing Number(圖面型號)	
Crimp Terminal		GJ-A1003TF-PTS	
Н	ousing	GJ-A1003HF-**-AON & GJ-A1003HF-**-AON 帶扣	
Wafer	Straight(直立式)	GJ-A1003WVS-**-FIN-HK	
water	Right Angle(臥式)	GJ-A1003WRS-**-FIN-HK	

Note: (xx) The number of the circuits

#### 2.0 Construction/Dimensions/Material & Surface Finish(材質以及表面鍍層):

Part Nan	1e(零件名稱)	Material(材質)	Surface Finish(表面鍍層)	
Crimp	Terminal	Phosphor Bronze	Tin-Plated	
(铆)	壓端子)	Pilospiloi Biolize	Gold-Plated	
Housing	(電線端連接器)	Nylon 66	UL 94V-0	
	Contact Pin (導體)	Phosphor Bronze	Gold / Tin / Matte-Tin Plated	
	Solder Nail (固定片)	Phosphor Bronze	Gold / Tin / Matte-Tin Plated	
Wafer		LCP	UL 94V-0 Color : Nature	
(電路板端連接器)	Base (膠體) LCP	LCP	UL 94V-0 Color : Nature	
		LCP	UL 94V-0 Color : Nature	
	Cap (真空吸著上蓋)	LCP	UL 94V-0 Color : Nature	

#### 3.0 Characteristic(產品特性):

	Item(項目)	Standard(標準規範)			
3.1	額定電流 Rated Current	1.0A AC/DC W	1.0A AC/DC With AWG #28 is applied (相對適用於美國電線規格 UL1571 AWG #28)		
3.2	額定電壓 Rated Voltage		50 V	AC/DC	
3.3	Ambient Temperature Range 環境與操作溫度範圍	(操作使用溫度與濕度範圍) Operating Temp.: -25℃~+85℃ ; 85% R.H. Max Including 30℃ Terminal Temperature Rise at rated Current , (包括定額電流內 ,端子所產生 30℃以下溫昇)			
3.4	Applicable Wire 適用電線	3.4.1 (金屬導體之型號) Conductor Construction Size: AWG #28~#32 3.4.2 (電線絕緣材質外徑) Wire Insulation O.D.: 0.65mm~0. mm			
3.5	Storage of Package 包裝未拆封之保存	Temperature a	nd Humidity Condition 溫濕度條件 Housing	Temperature 溫度:-10℃~+40℃ Percentage Humidity 相對濕度:70 % Max 2 Years	
		保存期限	Crimp Terminal & Wafer	1 Year	
3.6	Floor Life 拆封後使用期限	Wafer Crimp Terminal	Refer to 10.0 参照第 10.0 項 (IPC/JEDEC J-STD-020D.1 ; Table 5-1		





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#### 4.0 Specimen(樣本圖示):

	Part Name / Part Number / Picture or Photograph 零件名稱 / 零件型號 / 樣本圖示					
Crimp Terminal GJ-A1003TF-PTS		Housing GJ-A1003HF GJ-A1003HF 帶扣				
Wafer Straight GJ-A1003WVS		Wafer Right Angle GJ-A1003WRS				

#### 5.0 Applicable Standards(適用規範):

ANSI/EIA 364 ; EIA/ECA 364  $\,$  Testing method for electrical connectors.

電子連接器 ,所適用之 ANSI/EIA 364; EIA/ECA 364 測試規範

#### 6.0 Mechanical Performance(機械性能):

	Item(項目)	Test Condition(測試條件)		Requirement(規格)	
		Insert and withdrawal with connectors at the		插入力(最大值)	拔出力(最小值)
	Insertion	speed rate of 25 .4 ± 3 mm /minute. (Excluding		Insertion (Max)	Withdrawal (Min)
	& Withdrawal	Thumb Latch 不包含指壓彈簧卡榫結合力)			
6.1	Force	連接器兩端堪合,以每一分鐘 25.4 ± 3mm 的速率,	SINGLE	0 FN	0.511
	嵌入力與拔出力	作嵌入與拔出往返測試	PIN	3. 5N	0. 5N
		(EIA/ECA 364-13D)			
	Wire Pullout	Pull out the cable from with contact terminal at the		28 size wire	11N Min
6.2	Force(Axial)	speed rate of 25 .4± 3 mm/minute. 對端子所包覆電			7N Min
	電線脫離端子包覆	線,施以每一分鐘 25 .4± 3 mm 速率之軸向拔出力			
	之拔出力(軸向)	(EIA 364-08B )	AWG#32 size wire 5N Min		5N Min

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	Item(項目)	Test Condition(測試條件)	Requirement(規格)
6.3	Crimp Terminal Retention Force (in Housing) <b> </b>	Axial pullout force on the terminal in the housing at the speed rate of 25.4 ± 3 mm per minute. (EIA 364-05B) 對於已經存在於膠座當中铆線端子,施以每一分鐘 25.4 ± 3 mm 速率之軸向拔出力	Per Contact
6.4	Contact Retention Force(in Base) 金屬導體與膠座之間 保持力	Axial pullout force on the contact in the base at the speed rate of 25.4 ± 3 mm per minute. (EIA/ECA 364-29C) 對於已經存在於膠座當中金屬導體,施以每一分鐘25.4 ± 3mm速率之軸向拔出力	單一接觸點 Per Contact 最小容許值 2N/Min.

### 7.0 Electrical Performance(電氣性能):

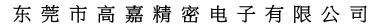
	Item(項目)	Test Condition(測試條件)	Requirement(規格)
7.1	(Low –Signal Level) Contact Resistance (低階信號) 接觸阻抗	A maximum voltage of 20mV and a maximum current of 100mA are applied to the mate connector. (EIA/ECA 364-23C) 對組合狀態下連接器 ,於其兩端施以最大測試電壓 20mV 以及最大測試電流 100mA ( Does not include wire resistance 不包含電線阻抗 )	Contact Resistance:  20 milliohms Max. 最大容許值. 20 毫歐姆
7.2	Insulation Resistance 絕緣阻抗	Apply 100V D/C for 1 minute between adjacent contacts to measure the insulation resistance. 對相鄰兩接觸導體,於一分鐘時間內施予 100V D/C 電壓,並量測其間絕緣阻抗值 (EIA 364-21C)	Insulation Resistance: Initial 100 megohms Min 最初容許值. 100 兆歐姆
7.3	Withstanding Voltage 耐電壓	Apply 500V A/C (rms) for 1 minute and the leakage current shall not exceed 0.5mA to the adjacent terminal and ground of the mate connectors. 對組合狀態下連接器,於其相鄰兩導體末端各施以電壓 500V A/C (實效值) 時間 1 分鐘,且漏電流必須小於 1mA(毫安培) (EIA 364-20C)	No breakdown or flashover. 無損毀或者產生火花



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#### 8.0 Environmental Performance(環境性能):

Item(項目)		Test Condition(測試條件)	Requirement(規格)
8.1	Durability 耐久性	Mate Connectors up 50 Cycles at a Maximun rate of 10 cycles  Per minute prior to environmental test 以組合狀態下連接器且未經環境測試,依每分鐘內進行10次嵌入與拔出之最大速率,連續50次嵌入與拔出往返測試 (EIA/ECA 364-09C)	(After the test) Contact resistance: 40 mΩ Max 經耐久性試驗後接觸阻抗: 最大容許值 40 毫歐姆
8.2	Temperature Rise (Via Current Cycling) 溫度上昇 (經由電流循環操作)	Mate connector . measure the temperature rise of contact when the maximum rated current is passed 以組合狀態下連接器 ,通過最大容許電流 量測其導體溫度上昇值 (EIA 364-70B Conditions 1 . Method 1)	Mate connectors  Temperature Rise: +30℃/Max.  組合狀態下之連接器溫度 上昇最大容許值+30℃
8.3	Vibration 耐振動	A mated connector shall be mounted on a printed Circuit board and subjected to a vibration test of the following conditions. During the test, test current continuity shall be checked. After the test, contact resistance shall be measured. 以組合狀態下連接器焊接於電路板作為試驗樣品,依照隨附如下規格要求,進行耐振動試驗,試驗過程中確認是否產生不連續電流(斷電)現象,並於試驗過後量測其接觸阻抗。 (EIA/ECA 364-28E-Condition I) Frequency(頻率): 10~55~10 Hz/minute. Amplitude (振幅): 1.5 mm P-P Direction (方向):1. Axis of up and down.上下軸向(Y 軸) 2. Axis of right the left. 左右軸向(X 軸) 3. Axis of front and back.前後軸向(Z 軸) Period(週期): 2 hours for each direction. (每一個軸向持續 2 小時)	Initial Contact Resistance 20 milliohms Max. 接觸阻抗最初容許值: 20 毫歐姆 (After the test) Contact Resistance: 40 milliohms Max. 经耐振動試驗後接觸阻抗:最大容許值 40 毫歐姆 No discontinuity current is longer than 1 microsecond 電流中斷現象,時間不可多於1微秒





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Pitch 1.00mm	Pitch 1.00mm SMT (Non-Halogen)Series Wire to Board Connector			

ı	Item(項目)	Test Condition(測試條件)	Requirement(規格)
			(After the test)
		A mated connector shall be placed in a humidity	Contact Resistance:
		chamber of the following conditions. After the test, leave	40 milliohms Max.
		the specimen at room temperature for 1~2 hours before	經恆溫恆濕試驗後接觸阻抗
		the contact resistance, the insulation resistance and the	最大容許值. 40 毫歐姆
	H	dielectric withstanding voltage shall be measured.	(After the test)
	Humidity	(EIA 364-31B Conditions III . Method A)	Insulation Resistance :
8.4	(Steady State)	以組合狀態下連接器放置於恆定溫度與濕度的空間,依照隨附	100 Megohms Min.
	恆溫恆濕	如下規格要求,進行恆溫恆濕試驗,經試驗過後將樣品置於室	經恆溫恆濕試驗後絕緣阻抗
		溫 1~2 小時,再量測其接觸阻抗、絕緣阻抗、以及耐電壓測試。	<b>最小容許值. 100 兆歐姆</b>
		Temperature(溫度):40±2℃.	<b>經恆溫恆濕試驗後測耐電壓</b>
		Relative Humidity(相對濕度): 90%~95% (RH).	(After the test)
		Period(週期) : 96 hours continuously. (持續 96 小時)	Withstanding Voltage:
			500V A/C for 1 minute
		A mated connector shall be subjected to a thermal shock	
		test of the following conditions. After the test, leave the	
		specimen at room temperature for 1~2 hours before the	
		contact resistance, the insulation resistance and the	
		dielectric withstanding voltage shall be measured.	
		以組合狀態下連接器作為試驗樣品,依照隨附如下規格要求,	
		進行冷熱衝擊試驗,經試驗過後將樣品置於室溫 1~2 小時,	
٠.	Thermal Shock	再量測其接觸阻抗、絕緣阻抗、以及耐電壓測試。	Same as paragraph 8.4
8.5	冷熱衝擊	(EIA/ECA 364-32D Conditions I . Method A)	同 8.4 章節
		One Cycle Consists Of:	
		-55℃+0/-3℃ for 30 minutes. → Room Temp. 5 minutes	
		85°C+3/-0°C for 30 minutes. → Room Temp. 5 minutes	
		Total Cycles: 5 Cycles.	
		以-55℃+0/-3℃溫度持續 30 分鐘 ,經室溫 5 分鐘 ,而後再以	
		85℃+3/-0℃溫度持續 30 分鐘,再經室溫 5 分鐘,構成一次	
		冷熱循環 ,總計循環次數 5 次。	





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Pitch 1.00mm	Engineering Dept.			

	Item(項目)	Test Condition(測試條件)	Requirement(規格)
8.6	Heat Aging 高溫老化試驗	A mated connector shall be placed in a heat oven of the following conditions. After the test, leave the specimen at room temperature for 1~2 hours before the contact resistance shall be measured. 以組合狀態下連接器放置於加熱烤箱當中,依照隨附如下規格要求,進行高溫老化試驗 ,經試驗過後將樣品置於室溫 1~2 小時,再量測其接觸阻抗。(EIA 364-17B Conditions III.Method A) Temperature(溫度): 85±2℃. Period(週期): 96 hours continuously. (持續 96 小時)	Initial Contact Resistance: 20 milliohms Max. 接觸阻抗最初容許值:20 毫歐姆 (After the test) Contact Resistance: 40 milliohms Max 經高溫老化試驗後接觸阻抗:最大容許值.40 毫歐姆
8.7	Salt Spray 鹽水噴霧	先沖后鍍端子作為試驗樣品,依照隨附如下規格要求,進行鹽水噴霧試驗,試驗過後將樣品用清水沖洗並經過自然風乾,而後觀察其外觀Density(鹽水密度): 5% in weight. Temperature(溫度): 35±2℃. Period(週期): Terminal or contact (Stamping before tin plated for 16 hours);端子或導體(先沖壓後電鍍 16 小時) Salt spray test only define the plating area,without plating area (as copper cross section) will not be defined.鹽水噴霧測試只判定電鍍區域,無電鍍區域(如折斷面裸銅)則不做判定	外观无损伤,应无露出底金属的严重锈蚀;使用预镀的型材, 落料面允许有不影响其性能的 轻微腐蚀 Appearance without damage, there should be no exposed bottom metal serious corrosion; Using pre-plated profiles, which The blanking surface is allowed to have slight corrosion without affecting its performance
8.8	Cold 耐寒試驗 (Low Temperature)	A mated connector shall be placed in a cold chamber of the following conditions. After the test, leave the specimen at room temperature for 1~2 hours before the contact resistance shall be measured.以組合狀態下連接器放置於低溫空間內,依照隨附如下規格要求,進行耐寒試験,經試験過後將樣品置於室溫 1~2 小時,再量測其接觸阻抗。(EIA 364-59A Procedure 4, Condition 2, Test Duration D) Temperature(溫度): -25±3℃.  Period(週期): 96 hours continuously. (持續 96 小時)	Initial Contact Resistance 20 milliohms Max. 接觸阻抗最初容許值 20 毫歐如 (After the test) Contact Resistance: 40 milliohms Max 經耐寒試験後接觸阻抗最大容許值 40 毫歐姆





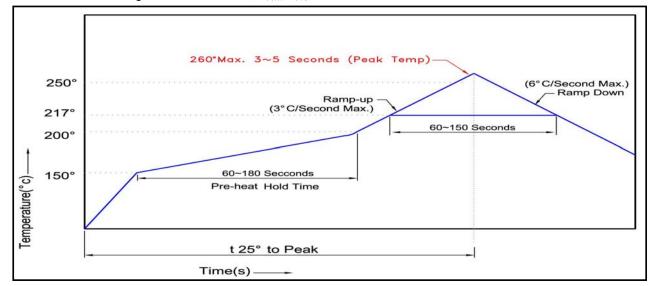
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Pitch 1.00mm						

	Item(項目)	Item(項目) Test Condition(測試條件)	
8.9	Solder Ability 焊錫性	Fluxed soldering section of header shall be dipped in solder of the following conditions. 將連接器 pin 針基板嵌入端,接觸熱溶狀錫料,依照隨附如下規格要求,進行焊錫性試驗(EIA364-52B)  Solder Temperature (焊錫溫度): 245 ± 5℃.  Immersion Period (沉浸週期): 3±0.5 Seconds (操作方式): 零件焊錫位置,距離導體以及固定片末端 0.5mm  Method: 0.5mm from contact pin and solder tab tip	Solder entirely 90% of immersed area must show no voids or pinholes.  學料覆蓋面積必須達到 90%,而且不能產生氣孔或空隙
8.10	Resistance To Soldering Heat 焊錫耐熱性	By reflow soldering 迴焊適用溫度範圍: Refer to Temperature Profile 請參考 8.10.1 溫度曲線圖 By soldering iron 手工烙鐵焊錫適用溫度範圍: 350 ± 5℃ 3±0.5 Seconds.  (操作方式): 零件焊錫位置 ,距離導體以及固定片末端 0.5mm Method: 0.5mm from contact pin and solder tab tip (EIA/ECA 364-56C Procedure 3. Conditions A)	No deformation or damage. 不可有變形或損壞

Notes: Flowing Mixed Gas (EIA 364-65A) shall be conduct by Customer request 混合流動氣體測試依照客戶需求

#### 8.10.1 Temperature Profile(溫度曲線圖):

IR Reflow Peak Soldering In-Pb Free Process 迴焊無鉛制程





## 东莞市高嘉精密电子有限公司

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Pitch 1.00mm	Pitch 1.00mm SMT (Non-Halogen)Series Wire to Board Connector			

9.0 Caution (注意事項): 1. Nylon 6T/66

Parts are made of hydrophilic Nylon 6T/66 and apt to absorb moisture. Once the vacuum-packing unpacked, please keep parts in the environment of temperature < 30℃/ humidity < 60% RH, and send to re-flowing within 48 hours to prevent parts blistered or deformed during soldering. 6T/66塑料因具親水之特性 ,故採用真空包裝以減少吸濕受潮。真空包裝經拆封應避免曝露於溫度高於30℃,濕度高於 60% RH的環境中,並在拆封48小時內全數使用完畢,以防止後續迴焊製程產生起泡變形現象。 2. Nylon 9T

Parts are made of hydrophilic Nylon 9T and apt to absorb moisture. Once the vacuum-packing unpacked, please keep parts in the environment of temperature < 30℃/ humidity < 60% RH, and send to re-flowing within 72 hours to prevent parts blistered or deformed during soldering.

9T塑料因具親水之特性,故採用真空包裝以減少吸濕受潮。真空包裝經拆封應避免曝露於溫度高於30℃,濕度高於 60% RH的環境中,並在拆封72小時內全數使用完畢,以防止後續迴焊製程產生起泡變形現象。3.LCP

Parts are made of hydrophilic LCP and apt to absorb moisture. Once the vacuum-packing unpacked, please keep parts in the environment of temperature < 30℃/ humidity < 60% RH, and send to re-flowing within 168hours to prevent parts blistered or deformed during soldering.

LCP塑料因具親水之特性,故採用真空包裝以減少吸濕受潮。真空包裝經拆封應避免曝露於溫度高於30℃,濕度高於 60% RH的環境中,並在拆封168小時內全數使用完畢,以防止後續迴焊製程產生起泡變形現象。

10.0 Remark(備註): Any change or revision for the product specification will not be announced in advance.

Please contact our sales representative for the latest information.

有關規格書內容經變更或改版 ,如未能夠及時發佈與通知 ,煩讀連絡我司業務人員以提供產品最新資

Reviewed: <u>Liangdong.Yi</u> Approved: <u>James.Kang</u> Verified: <u>James.Kang</u>